



1/5

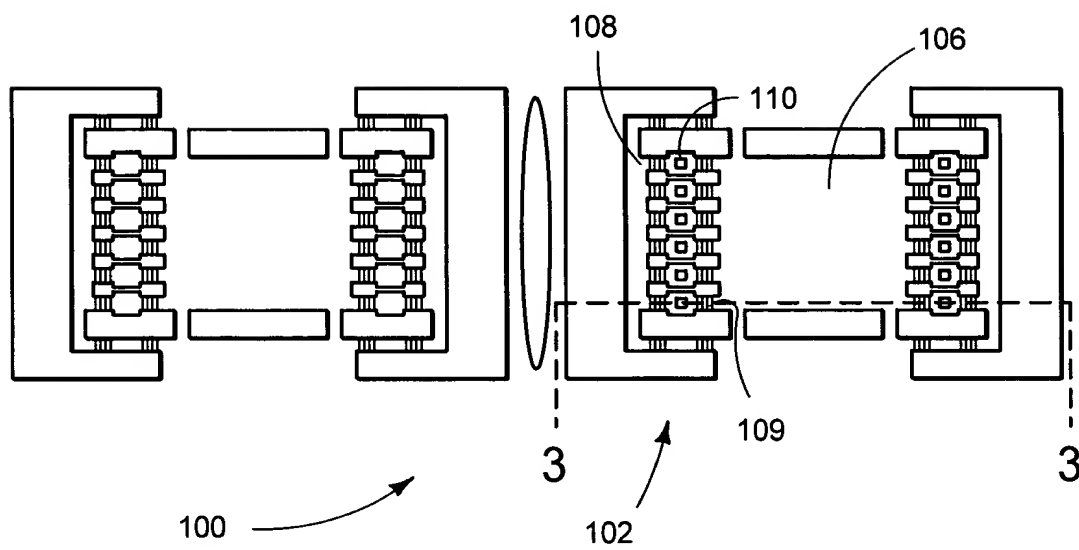


FIG. 1

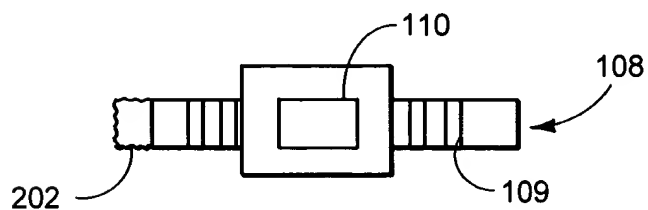


FIG. 2



2/5

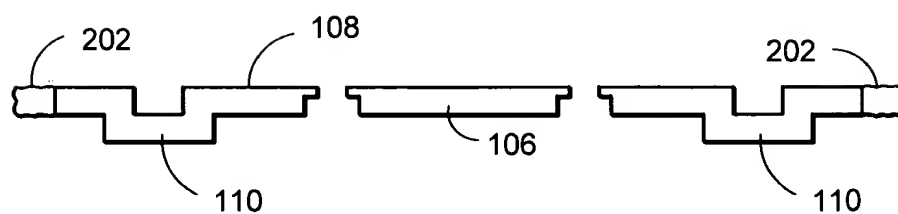


FIG. 3A

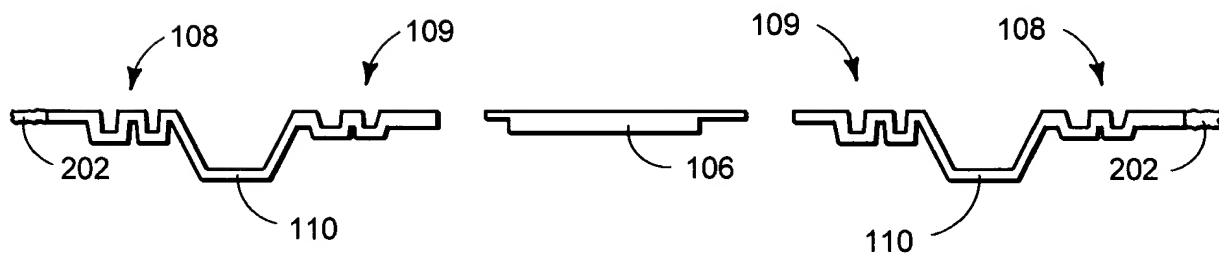


FIG. 3B

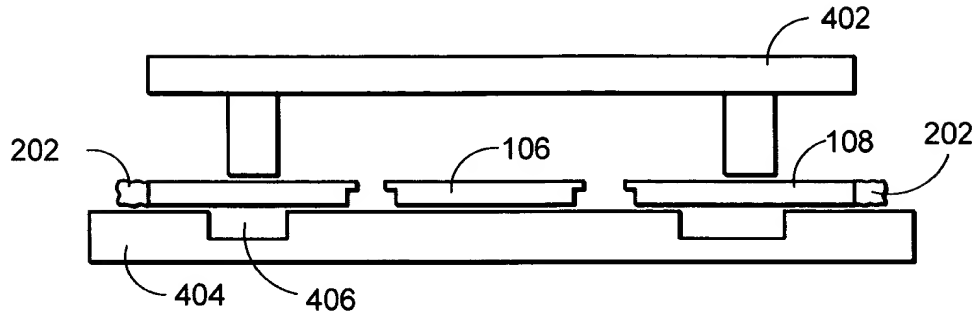


FIG. 4A

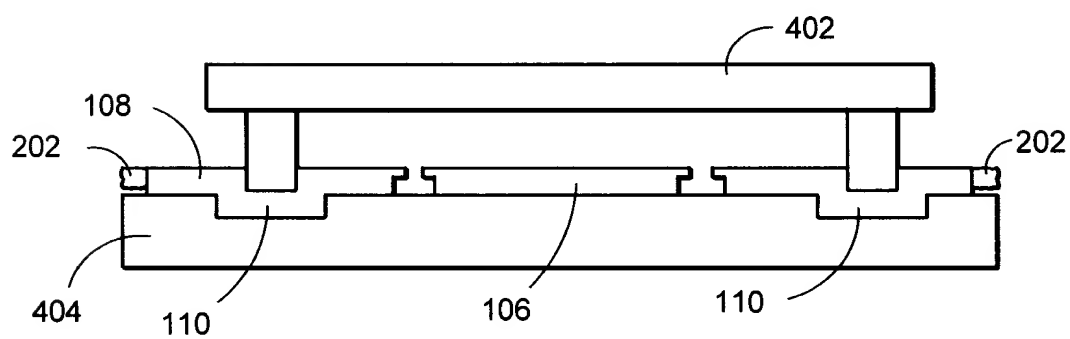


FIG. 4B

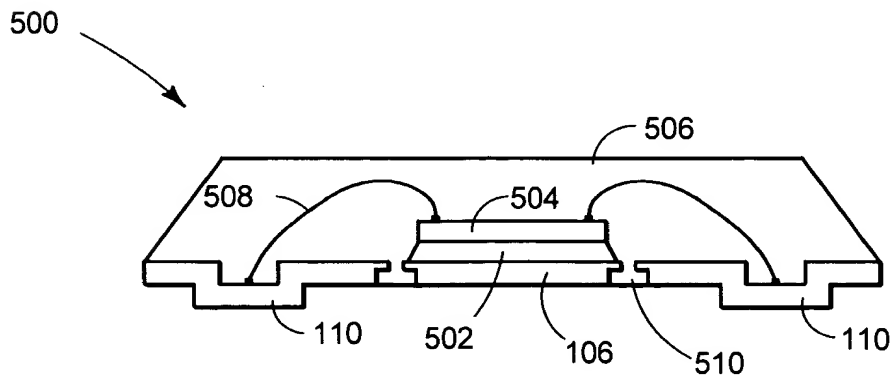


FIG. 5



4/5

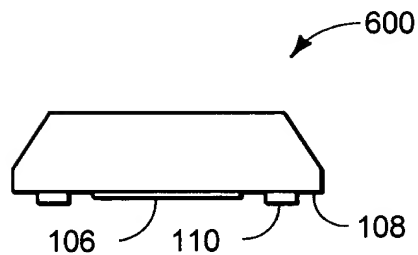


FIG. 6A

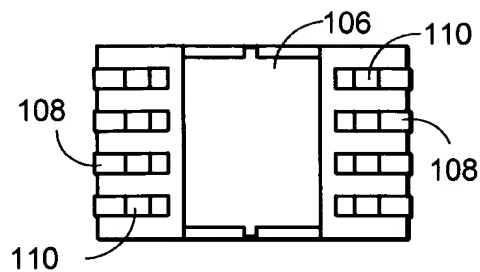


FIG. 6B

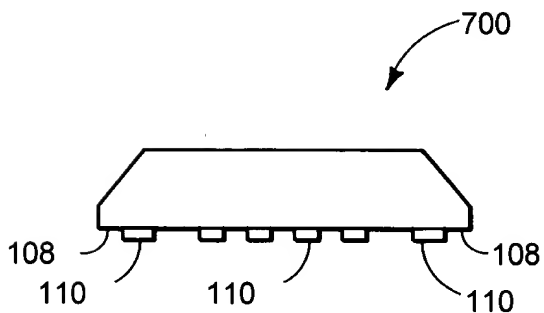


FIG. 7A

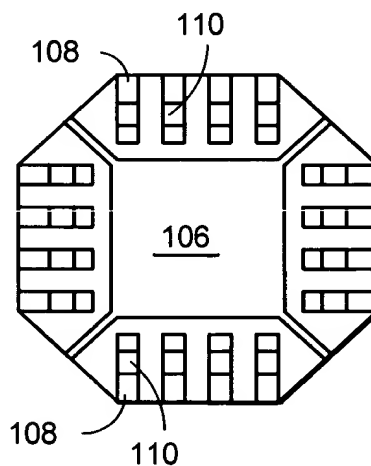


FIG. 7B



TITLE: BUMP CHIP LEAD FRAME AND PACKAGE  
INVENTOR: Hung V. Ngo  
SERIAL NO.: 09/736462 - DOCKET NO.: ONSSC0853AM  
REPLACEMENT SHEET

5/5

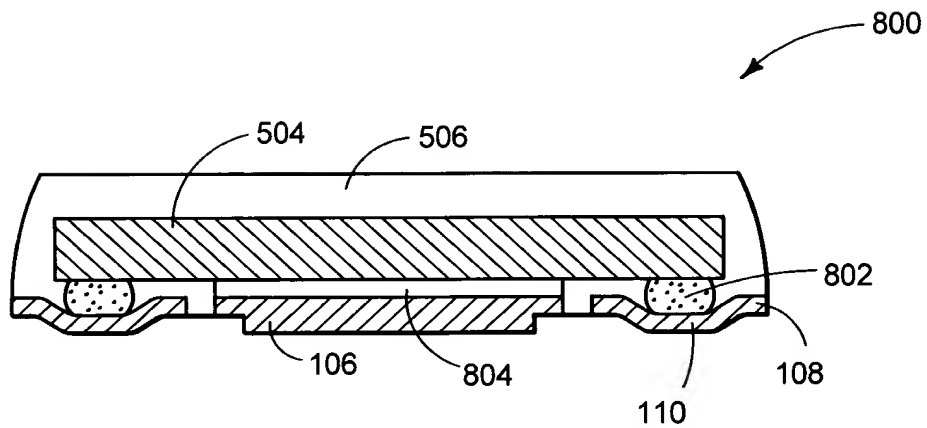


FIG. 8